

Preliminary datasheet 62 mm C-Series module with CoolSiC[™] Trench MOSFET

Features

- · Electrical features
 - V_{DSS} = 1200 V
 - $I_{DN} = 420 \text{ A} / I_{DRM} = 840 \text{ A}$
 - High current density
 - Low switching losses
- Mechanical features
 - 4 kV AC 1 min insulation

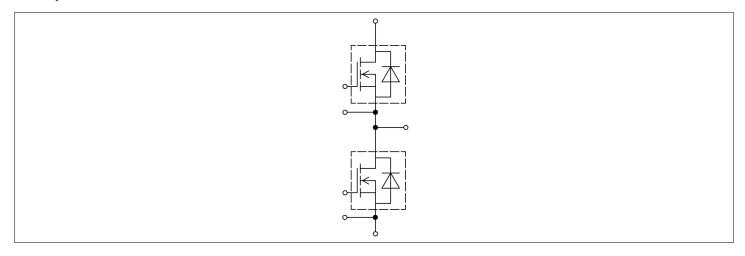
Potential applications

- UPS systems
- Solar applications
- DC/DC converter
- High-frequency switching application
- Energy storage systems
- · DC charger for EV

Product validation

• Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description





62 mm C-Series module



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62 mm C-Series module

1 Package



1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V _{ISOL}	RMS, f = 50 Hz, t = 60 s	4.0	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al ₂ O ₃	
Creepage distance	d_{Creep}	terminal to heatsink	29.0	mm
Creepage distance	d_{Creep}	terminal to terminal	23.0	mm
Clearance	d_{Clear}	terminal to heatsink	23.0	mm
Clearance	d_{Clear}	terminal to terminal	11.0	mm
Comparative tracking index	CTI		> 400	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition			Values		
				Min.	Тур.	Max.	
Stray inductance module	L _{sCE}				20		nH
Module lead resistance, terminals - chip	R _{CC'+EE'}	T_C = 25 °C, per switch			0.475		mΩ
Storage temperature	$T_{\rm stg}$			-40		125	°C
Mounting torque for module mounting	М	- Mounting according to valid application note	M6, Screw	3		6	Nm
Terminal connection torque	М	- Mounting according to valid application note	M6, Screw	2.5		5	Nm
Weight	G				340		g

2 MOSFET

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Drain-source voltage	V_{DSS}		T _{vj} = 25 °C	1200	V
Implemented drain current	I _{DN}			420	А
Continuous DC drain current	I _{DDC}	$T_{\rm vj}$ = 175 °C, $V_{\rm GS}$ = 18 V	T _C = 115 °C	290	А
Repetitive peak drain current	I _{DRM} verified by design, t _p limited by T _{vjmax}		ited by T _{vjmax}	840	А

62 mm C-Series module

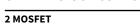




Table 3 (continued) Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Gate-source voltage, max. transient voltage	V_{GS}	D < 0.01	-10/23	V
Gate-source voltage, max. static voltage	V_{GS}		-7/20	V

Table 4 Recommended values

Parameter	Symbol	Note or test condition	Values	Unit
On-state gate voltage	V _{GS(on)}		1518	V
Off-state gate voltage	V _{GS(off)}		-50	V

Table 5 Characteristic values

Symbol	Note or test condition		Note or test condition Values			Unit
			Min.	Тур.	Max.	
R _{DS(on)}	I _D = 420 A	$V_{\rm GS} = 18 \text{ V},$ $T_{\rm vj} = 25 ^{\circ}\text{C}$		1.96		mΩ
		V _{GS} = 18 V, T _{vj} = 125 °C		3.17		
		V _{GS} = 18 V, T _{vj} = 175 °C		4.21		
		$V_{\rm GS} = 15 \text{ V},$ $T_{\rm vj} = 25 ^{\circ}\text{C}$		2.36		
V _{GS(th)}	I_D = 168 mA, V_{DS} = V_{GS} , T_{vj} = 25 °C, (tested after 1ms pulse at V_{GS} = +20 V)		3.45	4.3	5.15	V
Q _G	V _{DD} = 800 V, V _{GS} = -3/18 V			1.2		μC
R _{Gint}	T _{vj} = 25 °C			1.3		Ω
C _{ISS}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$	T _{vj} = 25 °C		36.3		nF
C _{OSS}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$	T _{vj} = 25 °C		1.8		nF
C _{rss}	$f = 100 \text{ kHz}, V_{DS} = 800 \text{ V},$ $V_{GS} = 0 \text{ V}$	T _{vj} = 25 °C		0.118		nF
E _{OSS}	$V_{\rm DS}$ = 800 V, $V_{\rm GS}$ = -3/18 V,	T _{vj} = 25 °C		709		μJ
I _{DSS}	$V_{\rm DS}$ = 1200 V, $V_{\rm GS}$ = -3 V	T _{vj} = 25 °C		0.24	527	μА
I _{GSS}	$V_{\rm DS} = 0 \text{ V}, T_{\rm vj} = 25 ^{\circ}\text{C}$	V _{GS} = 20 V			400	nA
	R _{DS(on)} V _{GS(th)} Q _G R _{Gint} C _{ISS} C _{rss} E _{OSS} I _{DSS}	$V_{\rm GS(th)}$ $I_{\rm D}$ = 420 A $I_{\rm DS(on)}$ $I_{\rm D}$ = 168 mA, $V_{\rm DS}$ = $V_{\rm GS}$, $T_{\rm Vj}$ after 1ms pulse at $V_{\rm GS}$ = +4 $I_{\rm GS}$ $I_{\rm DD}$ = 800 V, $I_{\rm GS}$ = -3/18 V $I_{\rm CSS}$ $I_{\rm $	$R_{\rm DS(on)} I_{\rm D} = 420 {\rm A} \qquad \qquad \begin{array}{c} V_{\rm GS} = 18 {\rm V}, \\ T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline V_{\rm GS} = 18 {\rm V}, \\ T_{\rm Vj} = 125 {\rm ^{\circ}C} \\ \hline V_{\rm GS} = 18 {\rm V}, \\ T_{\rm Vj} = 175 {\rm ^{\circ}C} \\ \hline V_{\rm GS} = 15 {\rm V}, \\ T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline \end{array}$ $V_{\rm GS(th)} I_{\rm D} = 168 {\rm mA}, V_{\rm DS} = V_{\rm GS}, T_{\rm Vj} = 25 {\rm ^{\circ}C}, ({\rm tested} {\rm after} 1 {\rm ms} {\rm pulse} {\rm at} {\rm V_{\rm GS}} = +20 {\rm V}) \\ Q_{\rm G} V_{\rm DD} = 800 {\rm V}, V_{\rm GS} = -3/18 {\rm V} \\ R_{\rm Gint} T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline C_{\rm ISS} f = 100 {\rm kHz}, V_{\rm DS} = 800 {\rm V}, T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline V_{\rm GS} = 0 {\rm V} \\ \hline C_{\rm CSS} f = 100 {\rm kHz}, V_{\rm DS} = 800 {\rm V}, T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline V_{\rm GS} = 0 {\rm V} \\ \hline C_{\rm FSS} f = 100 {\rm kHz}, V_{\rm DS} = 800 {\rm V}, T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline V_{\rm GS} = 0 {\rm V} \\ \hline V_{\rm DS} = 800 {\rm V}, V_{\rm GS} = -3/18 {\rm V}, T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline I_{\rm DSS} V_{\rm DS} = 800 {\rm V}, V_{\rm GS} = -3/18 {\rm V}, T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline V_{\rm DS} = 1200 {\rm V}, V_{\rm GS} = -3 {\rm V} T_{\rm Vj} = 25 {\rm ^{\circ}C} \\ \hline \end{array}$	$R_{\rm DS(on)} I_{\rm D} = 420 {\rm A} \qquad \qquad \begin{array}{c} V_{\rm GS} = 18 {\rm V}, \\ T_{\rm Vj} = 25 {\rm °C} \\ \hline V_{\rm GS} = 18 {\rm V}, \\ T_{\rm Vj} = 125 {\rm °C} \\ \hline V_{\rm GS} = 18 {\rm V}, \\ T_{\rm Vj} = 175 {\rm °C} \\ \hline V_{\rm GS} = 15 {\rm V}, \\ T_{\rm Vj} = 25 {\rm °C} \\ \hline \end{array}$ $V_{\rm GS(th)} I_{\rm D} = 168 {\rm mA}, V_{\rm DS} = V_{\rm GS}, T_{\rm Vj} = 25 {\rm °C}, ({\rm tested} {\rm after} 1{\rm ms} {\rm pulse} {\rm at} {\rm V}_{\rm GS} = +20 {\rm V}) \\ Q_{\rm G} \qquad V_{\rm DD} = 800 {\rm V}, V_{\rm GS} = -3/18 {\rm V} \\ R_{\rm Gint} \qquad T_{\rm Vj} = 25 {\rm °C} \\ \hline C_{\rm ISS} \qquad f = 100 {\rm kHz}, V_{\rm DS} = 800 {\rm V}, T_{\rm Vj} = 25 {\rm °C} \\ \hline C_{\rm OSS} \qquad f = 100 {\rm kHz}, V_{\rm DS} = 800 {\rm V}, T_{\rm Vj} = 25 {\rm °C} \\ \hline C_{\rm rss} \qquad f = 100 {\rm kHz}, V_{\rm DS} = 800 {\rm V}, T_{\rm Vj} = 25 {\rm °C} \\ \hline V_{\rm GS} = 0 {\rm V} \\ \hline E_{\rm OSS} \qquad V_{\rm DS} = 800 {\rm V}, V_{\rm GS} = -3/18 {\rm V}, T_{\rm Vj} = 25 {\rm °C} \\ \hline I_{\rm DSS} \qquad V_{\rm DS} = 1200 {\rm V}, V_{\rm GS} = -3 {\rm V} \qquad T_{\rm Vj} = 25 {\rm °C} \\ \hline I_{\rm DSS} \qquad V_{\rm DS} = 1200 {\rm V}, V_{\rm GS} = -3 {\rm V} \qquad T_{\rm Vj} = 25 {\rm °C} \\ \hline \end{tabular}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

(table continues...)

62 mm C-Series module

2 MOSFET



Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition			Values		Unit
				Min.	Тур.	Max.	
Turn-on delay time	$t_{\sf don}$	$I_{\rm D}$ = 420 A, $R_{\rm Gon}$ = 4.7 Ω ,	T _{vj} = 25 °C		143		ns
(inductive load)		$V_{\rm DD} = 600 \text{ V}, V_{\rm GS} = -3/18 \text{ V}$	T _{vj} = 125 °C		132		
			T _{vj} = 175 °C		130		
Rise time (inductive load)	t _r	$I_{\rm D} = 420 \text{ A}, R_{\rm Gon} = 4.7 \Omega,$	T _{vj} = 25 °C		153		ns
		$V_{\rm DD} = 600 \text{ V}, V_{\rm GS} = -3/18 \text{ V}$	T _{vj} = 125 °C		142		
			T _{vj} = 175 °C		127		
Turn-off delay time	$t_{\sf d\ off}$	V - COOV V - 3/10 V	T _{vj} = 25 °C		150		ns
(inductive load)			T _{vj} = 125 °C		162		1
			T _{vj} = 175 °C		169		
Fall time (inductive load)	t_{f}	V - COOV V - 2/10V	T _{vj} = 25 °C		33		ns
			T _{vj} = 125 °C		33		
			T _{vj} = 175 °C		34		
Turn-on energy loss per		T _{vj} = 25 °C		17.2		mJ	
pulse		$L_{\sigma} = 10 \text{ nH}, V_{GS} = -3/18 \text{ V},$ $R_{Gon} = 4.7 \Omega, \text{ di/dt} = 5.2$	T _{vj} = 125 °C		16.8		
		$kA/\mu s (T_{vj} = 175 °C)$	T _{vj} = 175 °C		17.2		
Turn-off energy loss per	$E_{ m off}$	$I_{\rm D}$ = 420 A, $V_{\rm DD}$ = 600 V,	T _{vj} = 25 °C		7.5		mJ
pulse		$L_{\sigma} = 10 \text{ nH}, V_{GS} = -3/18 \text{ V},$ $R_{Goff} = 1.5 \Omega, \text{ dv/dt} = 14.2$	T _{vj} = 125 °C		8		
		$kV/\mu s (T_{vj} = 175 °C)$	T _{vj} = 175 °C		8.4		
Thermal resistance, junction to case	R_{thJC}	per MOSFET				0.113	K/W
Thermal resistance, case to heat sink	R_{thCH}	per MOSFET, $\lambda_{grease} = 1 \text{ W}$	∕(m·K)		0.0320		K/W
Temperature under switching conditions	$T_{\rm vjop}$			-40		175	°C

Note:

The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Notes AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

Tvj, op > 150°C is allowed for operation at overload conditions for MOSFET and body diode. For detailed specifications, please refer to AN 2021-13.

62 mm C-Series module



3 Body diode (MOSFET)

3 Body diode (MOSFET)

Table 6 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit	
DC body diode forward	I _{SD}	$T_{\rm vj}$ = 175 °C, $V_{\rm GS}$ = -3 V	T _C = 115 °C	135	Α
current					

Table 7 Characteristic values

Parameter	Symbol	Note or test condition		l Note or test condition Values					Unit
				Min.	Тур.	Max.			
Forward voltage	V_{SD}	$I_{SD} = 420 \text{ A}, V_{GS} = -3 \text{ V}$	T _{vj} = 25 °C		4.22	5.59	V		
			T _{vj} = 125 °C		3.95				
			T _{vj} = 175 °C		3.85				

4 Characteristics diagrams

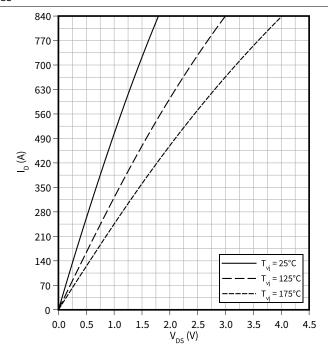


4 Characteristics diagrams

Output characteristic (typical), MOSFET

 $I_D = f(V_{DS})$

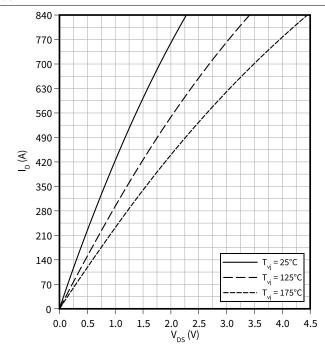
 $V_{GS} = 18 V$



Output characteristic (typical), MOSFET

 $I_D = f(V_{DS})$

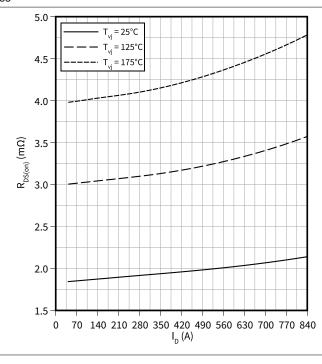
 $V_{GS} = 15 V$



Drain source on-resistance (typical), MOSFET

 $R_{DS(on)} = f(I_D)$

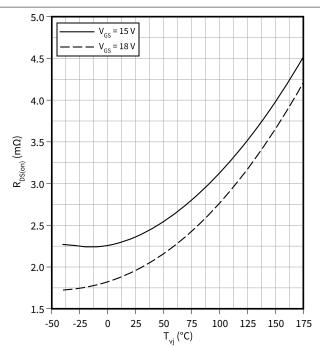
 $V_{GS} = 18 V$



Drain source on-resistance (typical), MOSFET

 $R_{DS(on)} = f(T_{vj})$

 $I_D = 420 A$



4 Characteristics diagrams

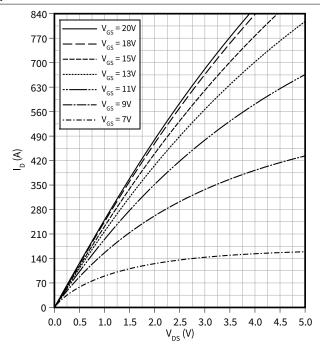




Output characteristic field (typical), MOSFET

 $I_D = f(V_{DS})$

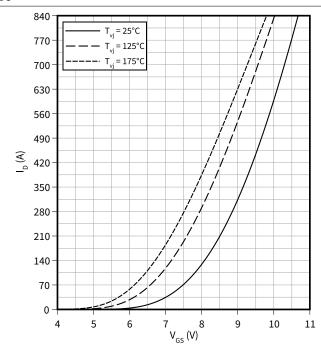
 $T_{vj} = 175$ °C



Transfer characteristic (typical), MOSFET

 $I_D = f(V_{GS})$

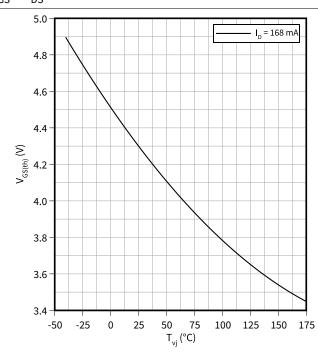
 $V_{DS} = 20 V$



Gate-source threshold voltage (typical), MOSFET

 $V_{GS(th)} = f(T_{vj})$

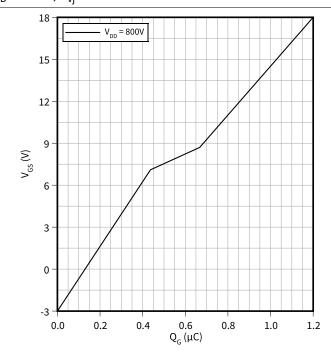
 $V_{GS} = V_{DS}$



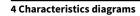
Gate charge characteristic (typical), MOSFET

 $V_{GS} = f(Q_G)$

 $I_D = 420 A$, $T_{vj} = 25 °C$



62 mm C-Series module

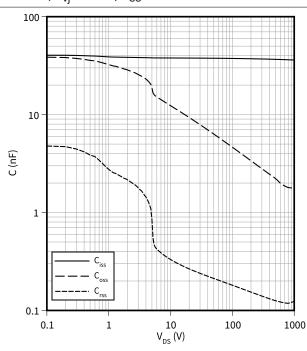




Capacity characteristic (typical), MOSFET

 $C = f(V_{DS})$

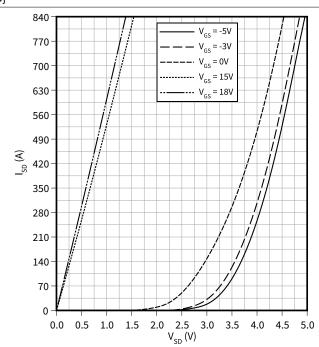
f = 100 kHz, $T_{vi} = 25 \,^{\circ}\text{C}$, $V_{GS} = 0 \,^{\circ}\text{V}$



Forward characteristic body diode (typical), MOSFET

 $I_{SD} = f(V_{SD})$

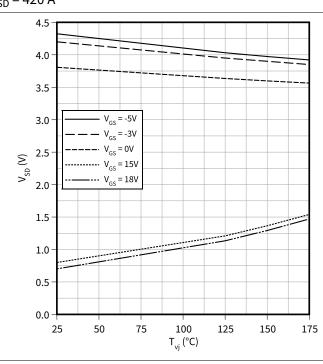
 T_{vj} = 25 °C



Forward voltage of body diode (typical), MOSFET

 $V_{SD} = f(T_{vi})$

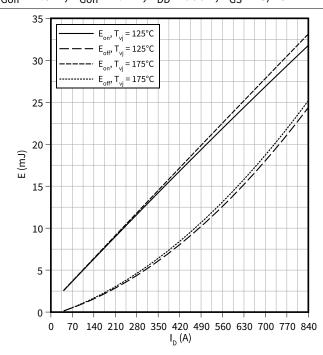
I_{SD} = 420 A



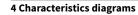
Switching losses (typical), MOSFET

 $E = f(I_D)$

 $R_{Goff} = 1.5 \Omega$, $R_{Gon} = 4.7 \Omega$, $V_{DD} = 600 V$, $V_{GS} = -3/18 V$



62 mm C-Series module

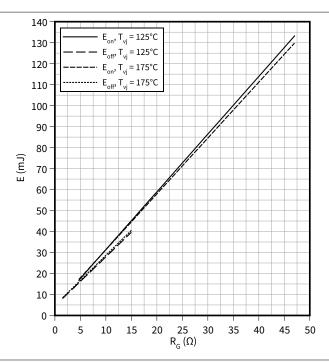




Switching losses (typical), MOSFET

 $E = f(R_G)$

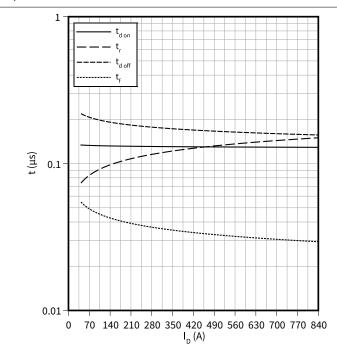
$$V_{DD}$$
 = 600 V, I_{D} = 420 A, V_{GS} = -3/18 V



Switching times (typical), MOSFET

 $t = f(I_D)$

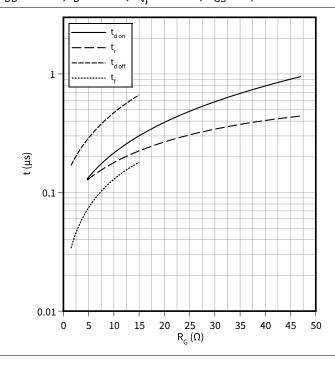
 R_{Goff} = 1.5 Ω , R_{Gon} = 4.7 Ω , V_{DD} = 600 V, T_{vj} = 175 °C, V_{GS} = -3/18 V



Switching times (typical), MOSFET

 $t = f(R_G)$

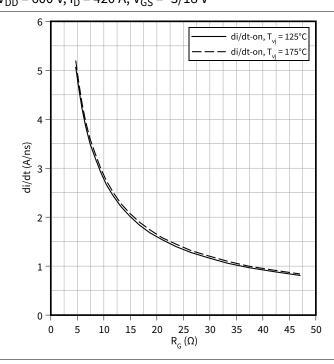
$$V_{DD}$$
 = 600 V, I_{D} = 420 A, T_{vj} = 175 °C, V_{GS} = -3/18 V



Current slope (typical), MOSFET

 $di/dt = f(R_G)$

 $V_{DD} = 600 \text{ V}, I_D = 420 \text{ A}, V_{GS} = -3/18 \text{ V}$



62 mm C-Series module

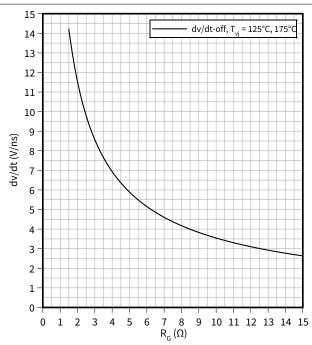


4 Characteristics diagrams

Voltage slope (typical), MOSFET

 $dv/dt = f(R_G)$

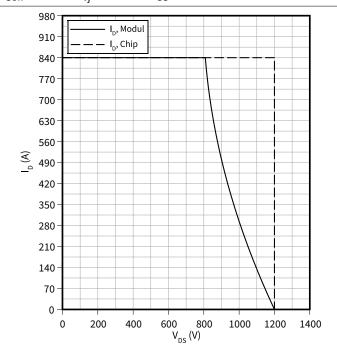
$$V_{DD}$$
 = 600 V, I_{D} = 420 A, V_{GS} = -3/18 V



Reverse bias safe operating area (RBSOA), MOSFET

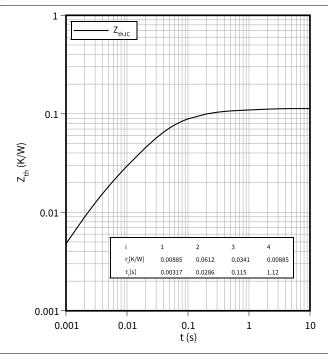
 $I_D = f(V_{DS})$

$$R_{Goff} = 1.5 \Omega$$
, $T_{vj} = 175 \,^{\circ}\text{C}$, $V_{GS} = -3/18 \,^{\circ}\text{V}$



${\bf Transient\ thermal\ impedance\ ,\ MOSFET}$

 $Z_{th} = f(t)$



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5 Circuit diagram

5 Circuit diagram

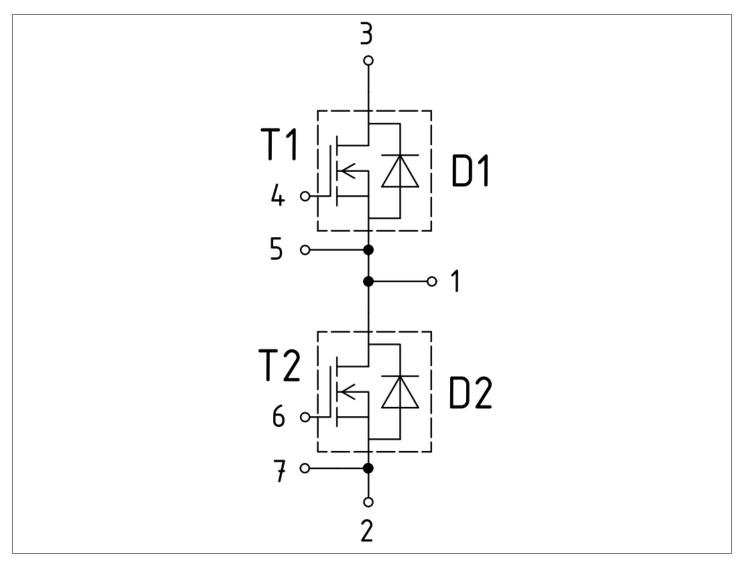


Figure 1

6 Package outlines



6 Package outlines

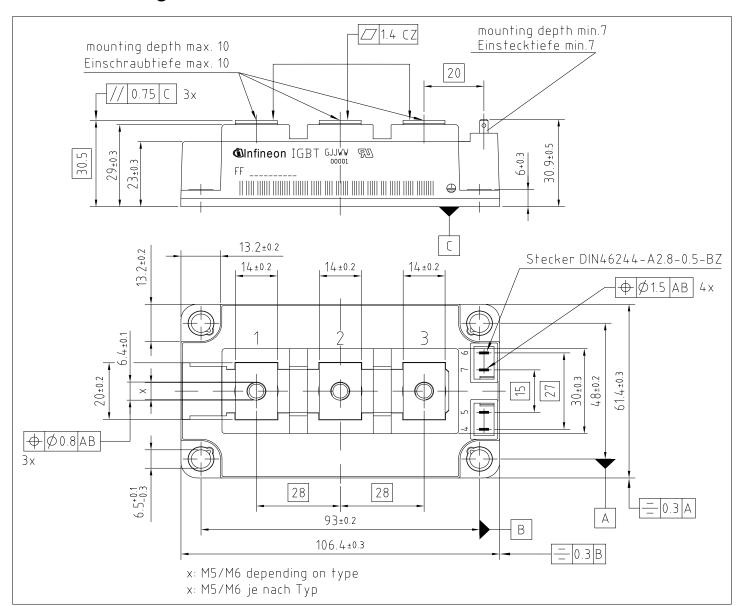


Figure 2

62 mm C-Series module

7 Module label code



7 Module label code

Module label cod			1			
Code format	Data Matrix		Barcode C	Code128		
Encoding	ASCII text		Code Set	A		
Symbol size	16x16		23 digits			
Standard	IEC24720 and IEC16022		IEC8859-1			
Code content	Content	Digit		Example		
	Module serial number	1-5		71549		
	Module material number	6 - 11		142846		
	Production order number	12 - 19		55054991		
	Date code (production year)	20 – 21		15		
	Date code (production week)	22 – 23		30		
Example						

Figure 3

62 mm C-Series module



Revision history

Revision history

Document revision	Date of release	Description of changes
0.10	2023-01-20	Initial version
0.20	2023-03-02	Preliminary datasheet

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